

Data brief

## VND7E040AJ evaluation board



**Product status link** 

EV-VND7E040AJ

**Product summary** 

EV-VND7E040AJ

VND7E040AJ

evaluation board

GAPG1704141052CF

#### **Features**

| Max transient supply voltage                                 | V <sub>CC</sub>           | 40 V      |
|--|---------------------------|-----------|
| Operating voltage range                                      | V <sub>CC</sub>           | 4 to 28 V |
| Typ. on-state resistance (per Ch)                            | R <sub>ON</sub>           | 38 mΩ     |
| Current limitation (typ)                                     | I <sub>LIMH</sub>         | 38 A      |
| Stand-by current (max)                                       | I <sub>STBY</sub>         | 0.5 μΑ    |
| Minimum cranking supply voltage (V <sub>CC</sub> decreasing) | V <sub>USD_cranking</sub> | 2.85 V    |

- Simple single IC application board dedicated for VND7E040AJ
- · Provides electrical connectivity and thermal heat-sinking for easy prototyping
- · General device features
  - Extreme low voltage operation for deep cold cranking applications (compliant to LV124, revision 2013)
  - Double channel smart high-side driver with CurrentSense analog feedback
  - Very low standby current
  - Compatible with 3 V and 5 V CMOS outputs
- Diagnostic functions
  - Analog feedback of load current with high precision proportional current mirror
  - Overload and short to ground (power limitation) indication
  - Thermal shutdown indication
  - OFF-state open-load detection
  - Output short to V<sub>CC</sub> detection
  - Sense enable/disable
- Protections
  - Undervoltage shutdown
  - Overvoltage clamp
  - Load current limitation
  - Self limiting of fast thermal transients
  - Configurable latch-off on overtemperature or power limitation with dedicated fault reset pin
  - Loss of ground and loss of V<sub>CC</sub>
  - Reverse battery with external components
  - Electrostatic discharge protection

### **Applications**

- Automotive resistive, inductive and capacitive loads
- Protected supply for ADAS systems: radars and sensors
- Automotive headlamp



### **Description**

This board provides you an easy way to connect STMicroelectronics VIPower M0-7 technology into your existing system.

The board comes pre-assembled with VND7E040AJ high-side driver. On board minimum set of electrical components (as for device datasheet recommendation) is enabling the user to directly connect the load, the power supply and the microcontroller without any additional effort in external component design and connection.

The VND7E040AJ is a single channel high-side driver manufactured using ST proprietary VIPower technology and housed in PowerSSO-16 package. The device is designed to drive 12 V automotive grounded loads through a 3 V and 5 V CMOS-compatible interface, providing protection and diagnostics.

The device integrates advanced protective functions such as load current limitation, overload active management by power limitation and overtemperature shutdown with configurable latch-off.

A FaultRST pin unlatches the output in case of fault or disables the latch-off functionality.

A dedicated multifunction multiplexed analog output pin delivers sophisticated diagnostic functions including high precision proportional load current sense, supply voltage feedback and chip temperature sense, in addition to the detection of overload and short circuit to ground, short to VCC and OFF-state open-load. A sense enable pin allows OFF-state diagnosis to be disabled during the module low-power mode as well as external sense resistor sharing among similar devices.

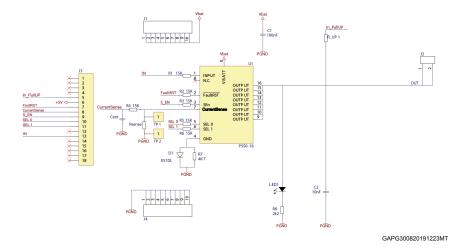


Figure 1. Evaluation board schematic

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## 1 Board connections

Figure 2. Evaluation board connections shows the placement of the connectors to be used to supply the evaluation board, to connect the load and to control the functionality and diagnostic of the device.

OUT0 - First power output

OUT1 - Second power output

TP1 - TP2 - Connector for plugging sense resistor

VBAT - Connection to battery (12 V)

J3 - Control and diagnostic

Figure 2. Evaluation board connections

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Table 1. J3 connector: pin functions

| Connector | Pin number | Pin name     | Pin function  |
|-----------|------------|--------------|---|
| J3        | 14         | N/A          | Not connected.  |
| J3        | 5          | IN_PullUP    | Connection to optional external pull-up resistor for open load detection in off-state.  |
| J3        | 6          | +5V          | 5 V Power Supply.   |
| J3        | 7          | FaultRST     | Active low compatible with 3 V and 5 V CMOS outputs pin; it unlatches the output in case of fault; If kept low, sets the outputs in auto-restart. |
| J3        | 8          | CurrentSense | Analog current sense output pin; delivers a current proportional to the selected load current.  |
| J3        | 9          | S_EN         | Active high compatible with 3 V and 5 V CMOS outputs pin; it enables the CurrentSense diagnostic pin.   |
| J3        | 10         | SEL0         | Active high compatible with 3 V and 5 V CMOS outputs pin; together with SEL1, it addresses the CurrentSense multiplexer.                          |
| J3        | 11         | SEL1         | Active high compatible with 3 V and 5 V CMOS outputs pin; together with SEL0, it addresses the CurrentSense multiplexer.                          |
| J3        | 12         | N/A          | Not connected.  |
| J3        | 13         | IN0          | Voltage controlled input pin with hysteresis, compatible with 3 V and 5 V CMOS outputs. It controls OUT0 switch state.                            |
| J3        | 14         | IN1          | Voltage controlled input pin with hysteresis, compatible with 3 V and 5 V CMOS outputs. It controls OUT1 switch state.                            |
| J3        | 1518       | N/A          | Not connected.  |

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In case the user wishes to use the CurrentSense/MultiSense function of the device, it is necessary to plug a sense resistor in  $R_{\text{SENSE}}$ .

The package includes a through-hole resistor, to be mounted on TP1-TP2 (see Figure 4. Mounting through-hole sense resistor).

Different R<sub>SENSE</sub> values can be adopted based on user preference.

Another option is soldering an SMD resistor on the dedicated PCB pad, as shown in Figure 5. Pads for soldering SMD resistor.

Figure 3. No sense resistor



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Figure 4. Mounting through-hole sense resistor



GAPG1004141007CFT

Figure 5. Pads for soldering SMD resistor



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# 2 Thermal data

Table 2. Thermal data

| Symbol               | Parameter                                 | Max | Unit |
|----------------------|---|-----|------|
| R <sub>thj-amb</sub> | Thermal resistance junction-ambient (max) | 39  | °C/W |

Table 3. PCB specifications

| Parameter               | Value           |  |
|-------------------------|-----------------|--|
| Board dimensions        | 25 mm x 41.5 mm |  |
| Number of Cu layer 2    |                 |  |
| Layer Cu thickness      | 35 μm           |  |
| Board finish thickness  | 1.6 mm +/- 10%  |  |
| Board Material          | FR4             |  |
| Thermal vias separation | 1.1 mm          |  |
| Thermal vias diameter   | 0.5 mm          |  |

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# **Revision history**

Table 4. Revision history

| Date        | Revision | Changes          |
|-------------|----------|------------------|
| 02-Sep-2019 | 1        | Initial release. |

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